

Radiation hardness tests at JINR

Alexey Zhemchugov
JINR Dubna

FCAL Workshop, September 19, 2016
Tel Aviv University

GaAs:Cr after 1.5 MGy

JINST 7 P11022 2012

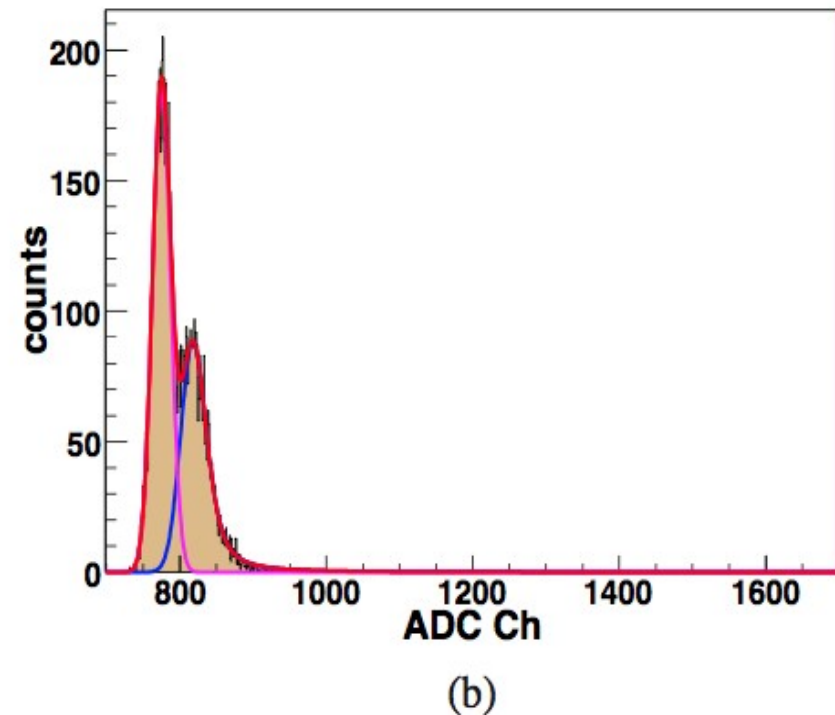
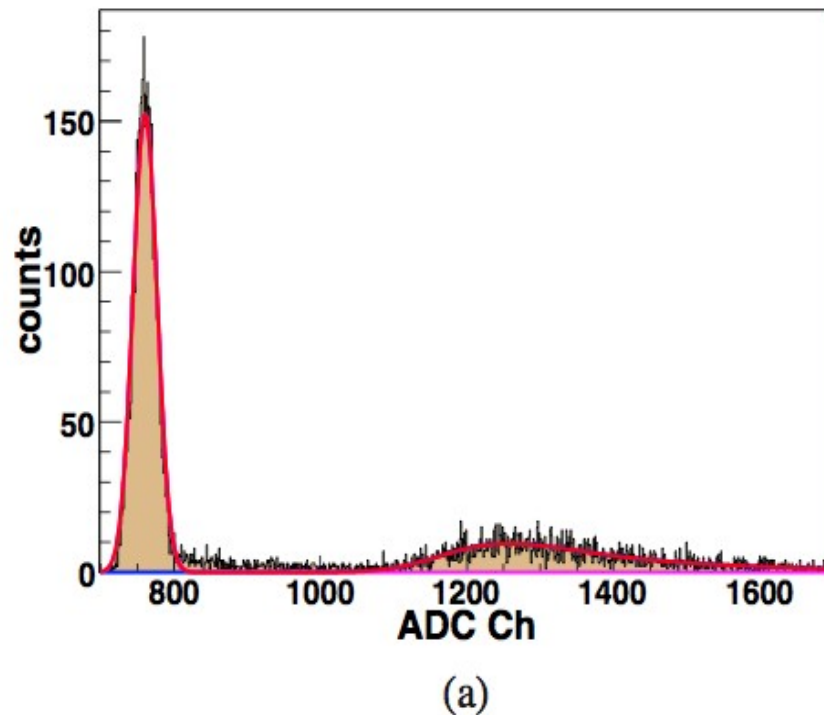


Figure 5: Spectrum from an unirradiated sensor GaAs2 (a) and from the same sensor after absorbing a dose of 1.5 MGy (b).

The idea of Tomsk GaAs:Cr

- **LEC SI-GaAs — commercially available**
 - difficult to control the impurities at low level
 - EL2 centers capture the electrons ($\tau \sim 0.2$ ns)
- **n-type SI-GaAs = LEC Si-GaAs doped with $N_d \sim 10^{17}$ donors (Sn or Te)**
 - also commercially available
 - EL2 centers are compensated
 - n-type, low resistivity
- **Compensated GaAs = n-type SI-GaAs compensated with Cr (or Fe)**
 - high resistivity (=low free carrier concentration)
 - type depends on Cr concentration: p-type (π -type) if $N_{Cr} > N_d$ and n-type (v-type) if $N_{Cr} < N_d$
 - N_{Cr} and N_d are 'macroscopic': it is possible to control the material properties in wide range

Two types of GaAs:Cr detectors

- 'Resistive' GaAs:Cr

- resistivity $\sim 10^9 \text{ } \Omega\text{m}\cdot\text{cm}$
- active thickness up to 1 mm
- electron drift length up to 2 mm

v-type GaAs:Cr

- $\pi\nu$ junction structure

- active thickness is determined by $\pi\nu$ junction ($\sim 0.1\text{-}0.2 \text{ mm}$ depending on U_{bias})
- resistivity and CCE is Ok

π -type GaAs:Cr

v-type GaAs:Cr

n-type GaAs

Radiation hardness tests of 199x - protons

V.B. Chmilt et al. / Nucl. Instr. and Meth. in Phys. Res. A 395 (1997) 65-70

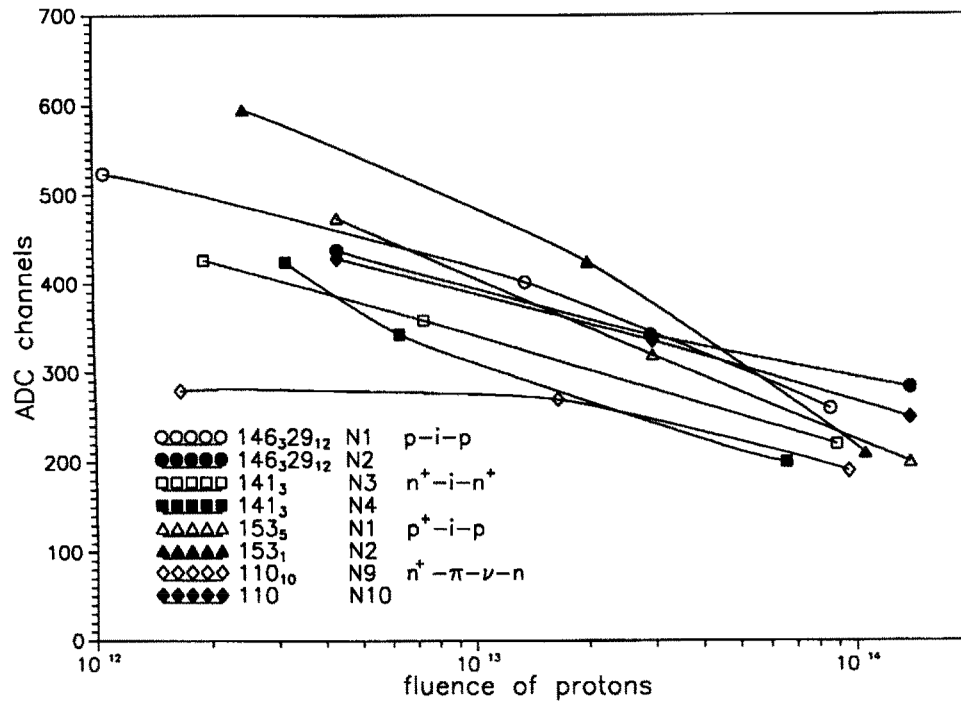


Fig. 2. Proton irradiation, first run.

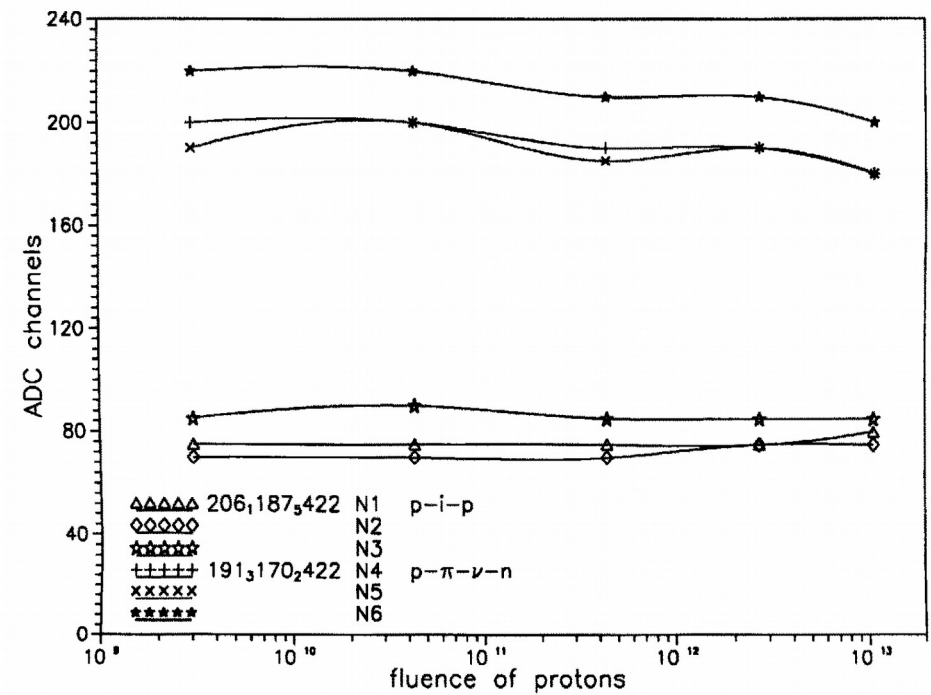


Fig. 3. Proton irradiation, second run.

1 GeV protons from Protvino booster
Two different irradiation rates

Radiation hardness tests of 199x - neutrons

V.B. Chmill et al. / Nucl. Instr. and Meth. in Phys. Res. A 395 (1997) 65–70

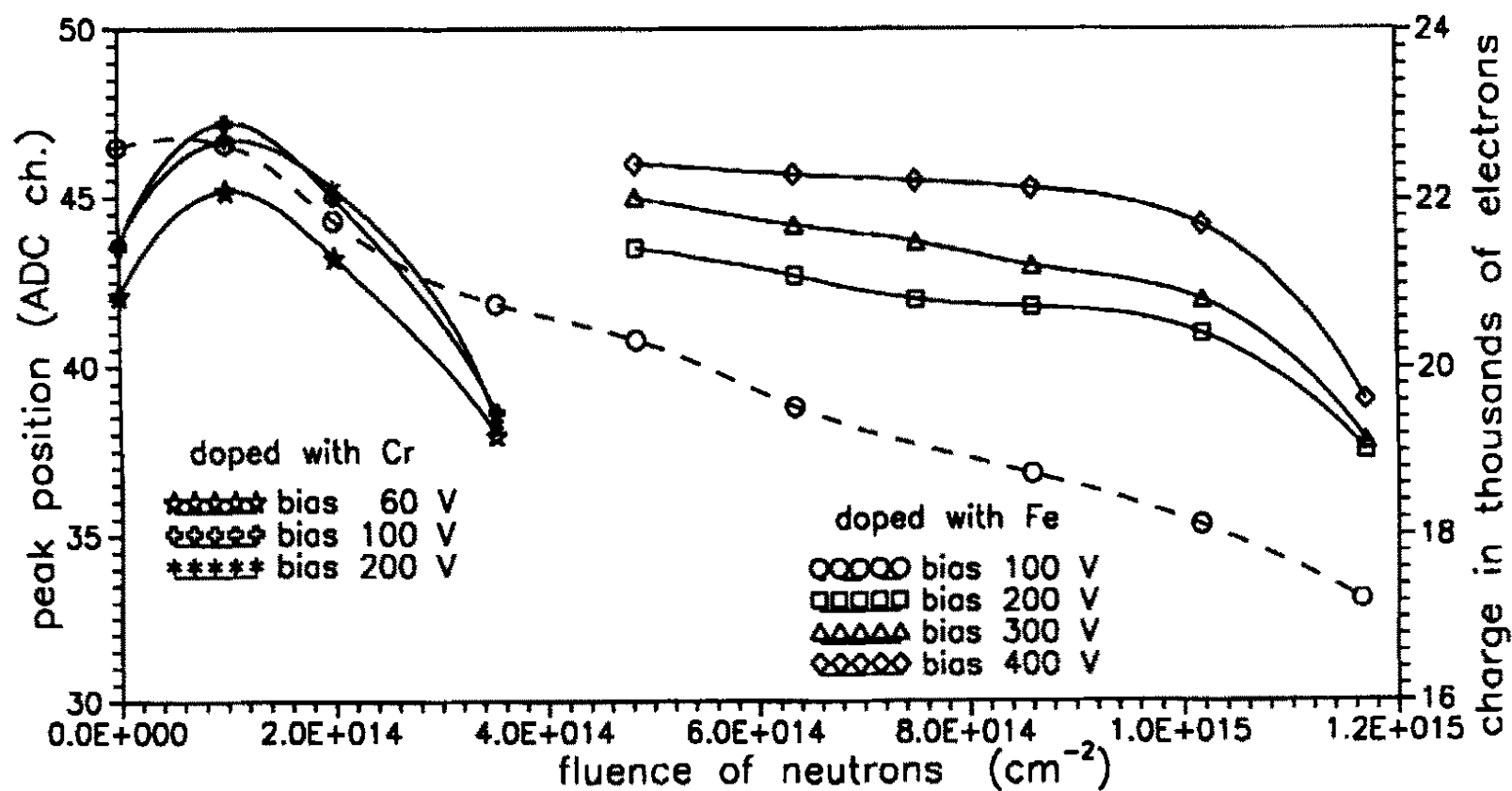


Fig. 1. Neutron irradiation.

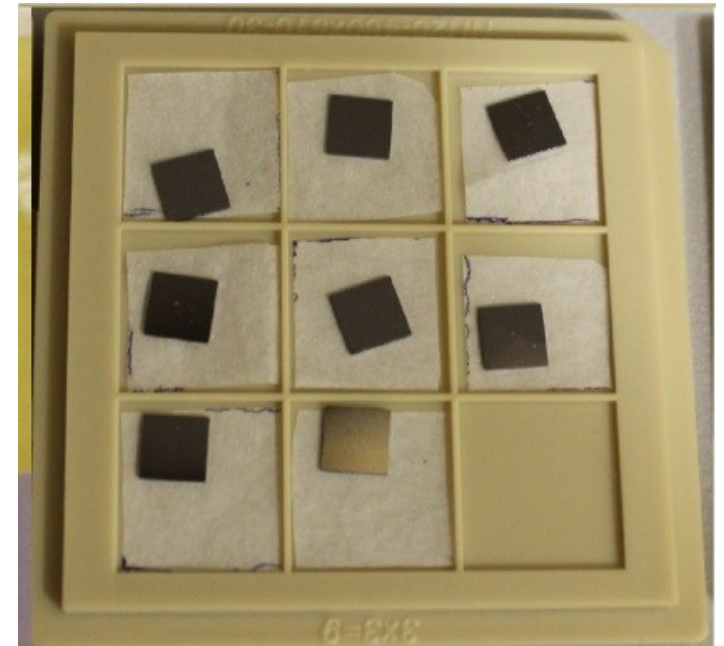
Conclusions possibly important to FCAL

- GaAs:Cr and GaAs:Fe detectors based on π v junction structure may have the same or better radiation hardness comparing with the 'resistive' GaAs:Cr
- π v junction structures were never tested systematically in electron beams.
- Last radiation hardness studies of detectors like these took place about 20 years ago
- We never reported (= never systematically studied) the dependence of the radiation degradation on the irradiation rate

Pad Detectors at JINR

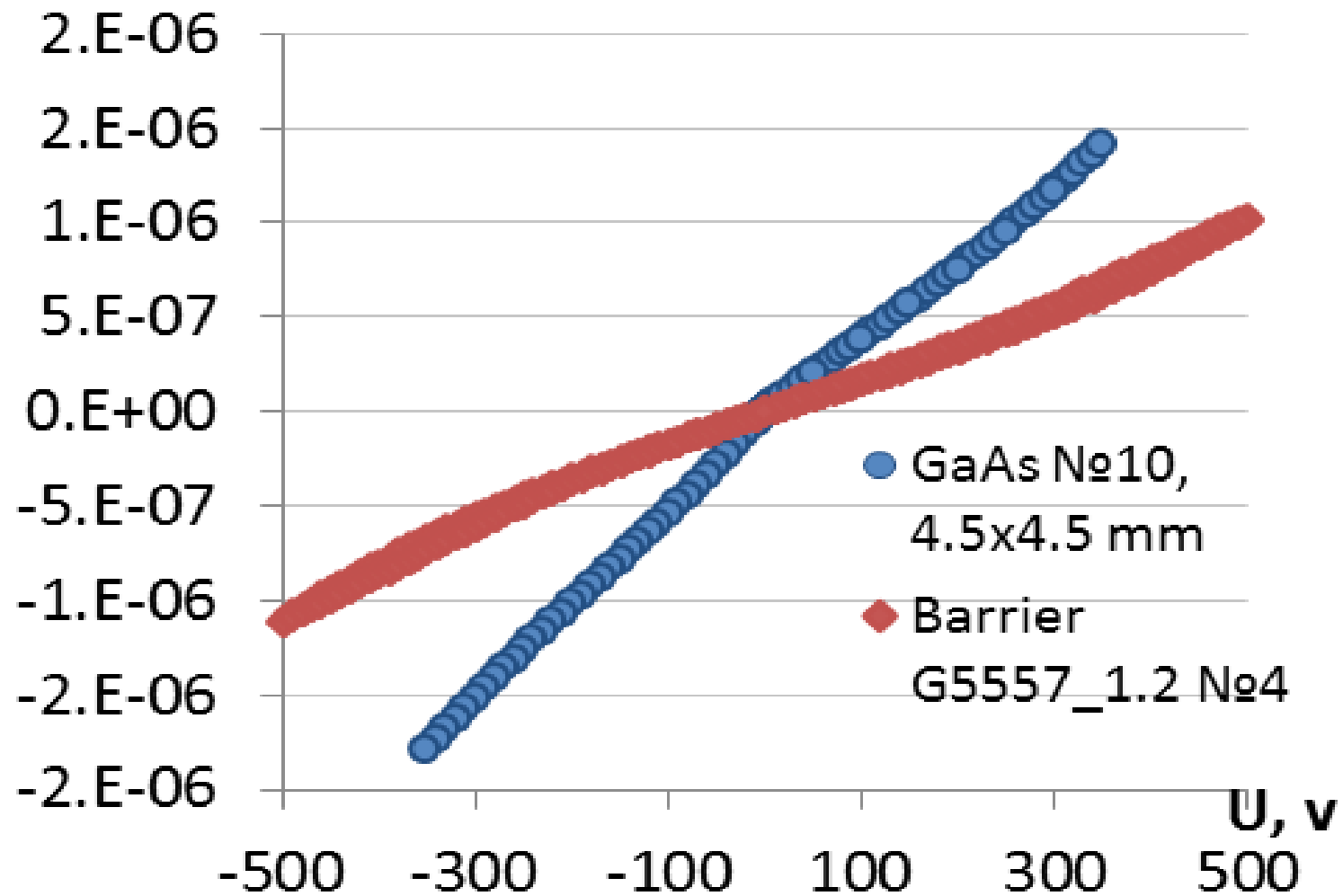
About 50 GaAs pad detectors based on $\pi\nu$ junction of different type have been manufactured in Tomsk by our request

- 6 wafers with different dopant concentration and diffusion regime
- thickness of 300 μm
- carrier electron concentration from $8 \cdot 10^{16}$ to $3 \cdot 10^{17} \text{ cm}^{-3}$



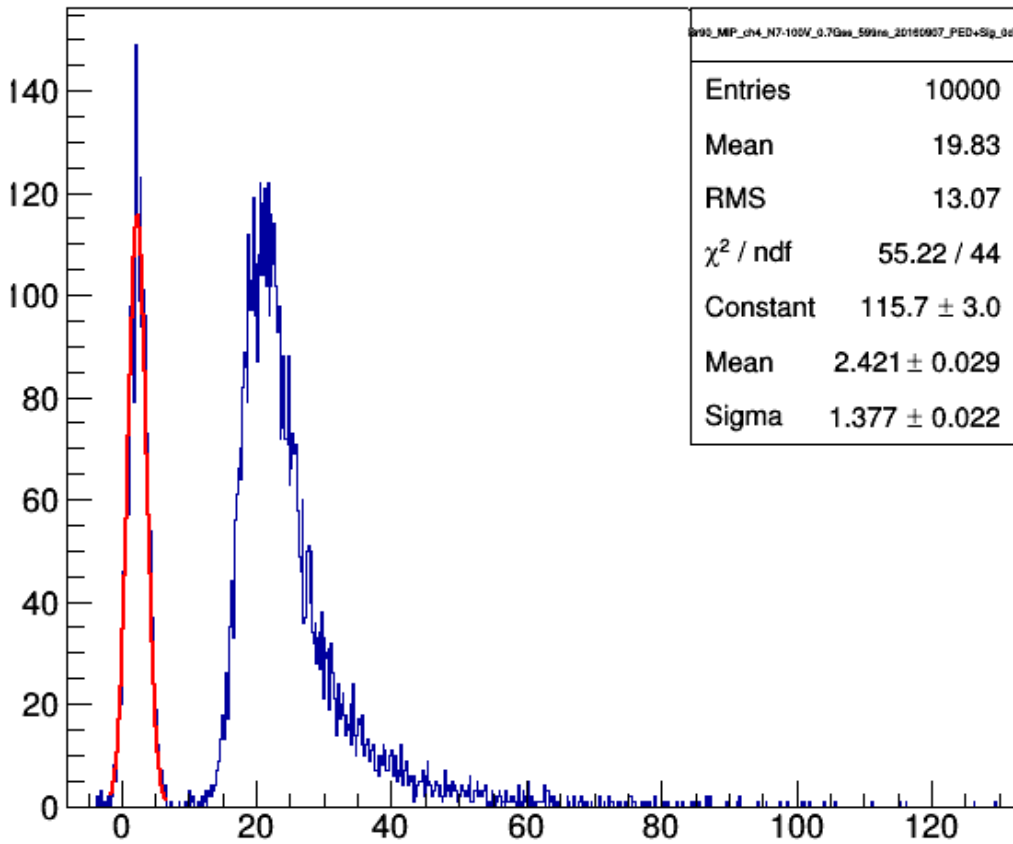
Characterisation before irradiation was already made in collaboration with ISS (Romania)

IV measurement



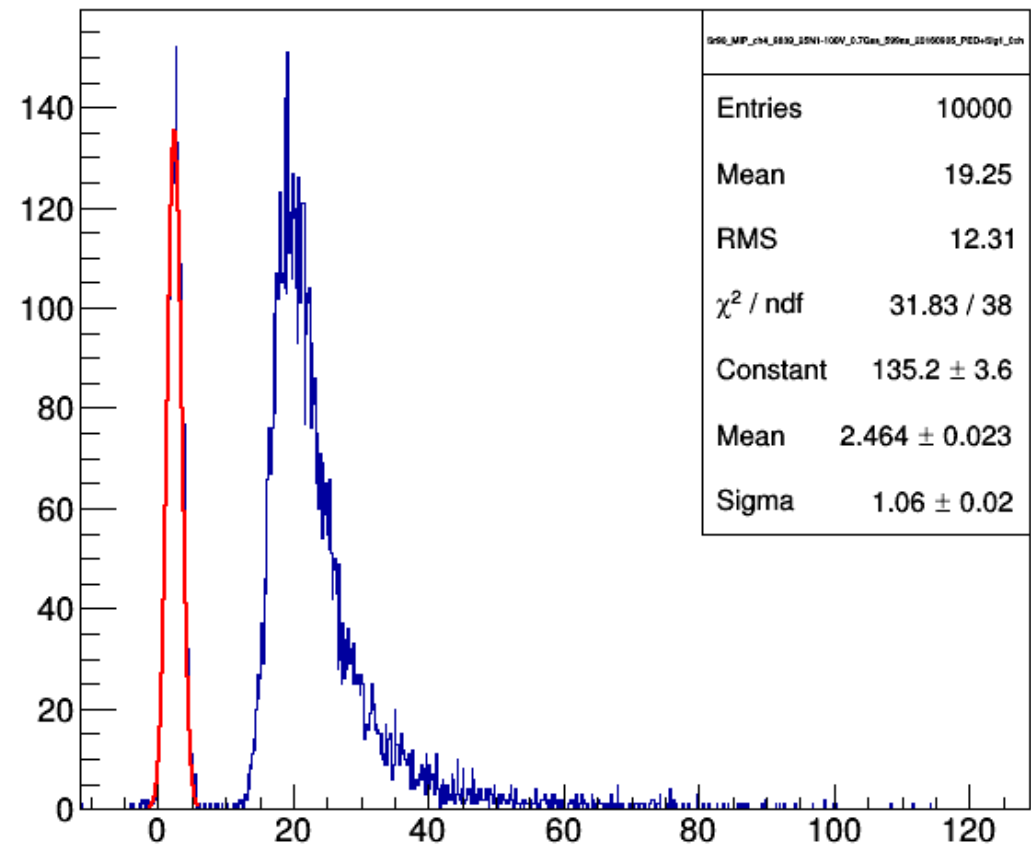
MIP spectra

Sr90_MIP_ch4_N7-100V_0.7Gss_599ns_20160907_PED+Sig_0ch



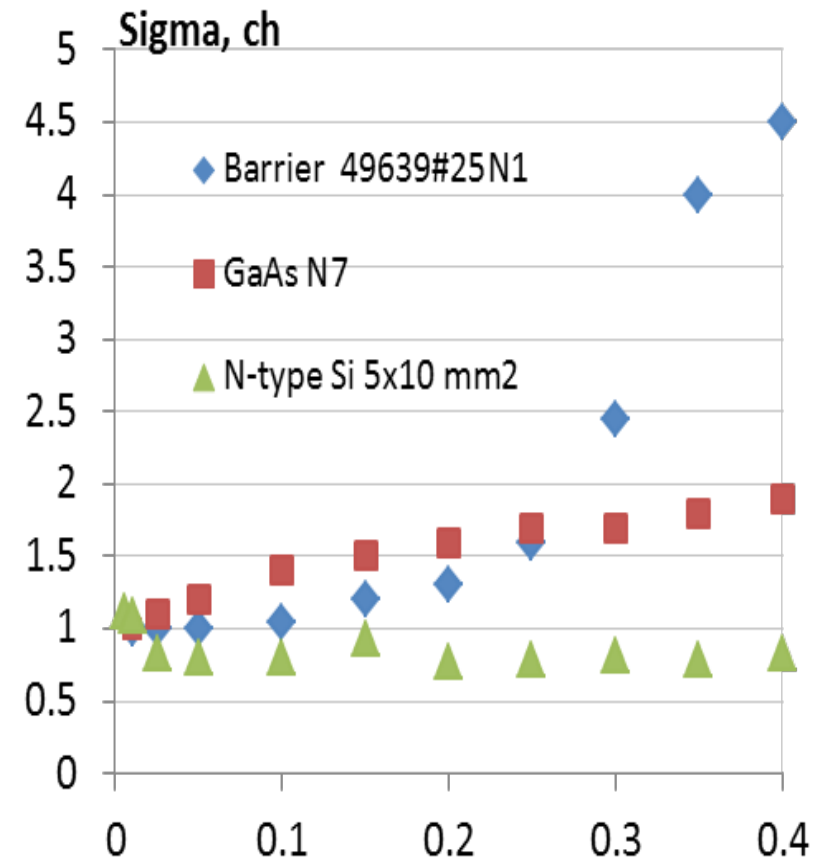
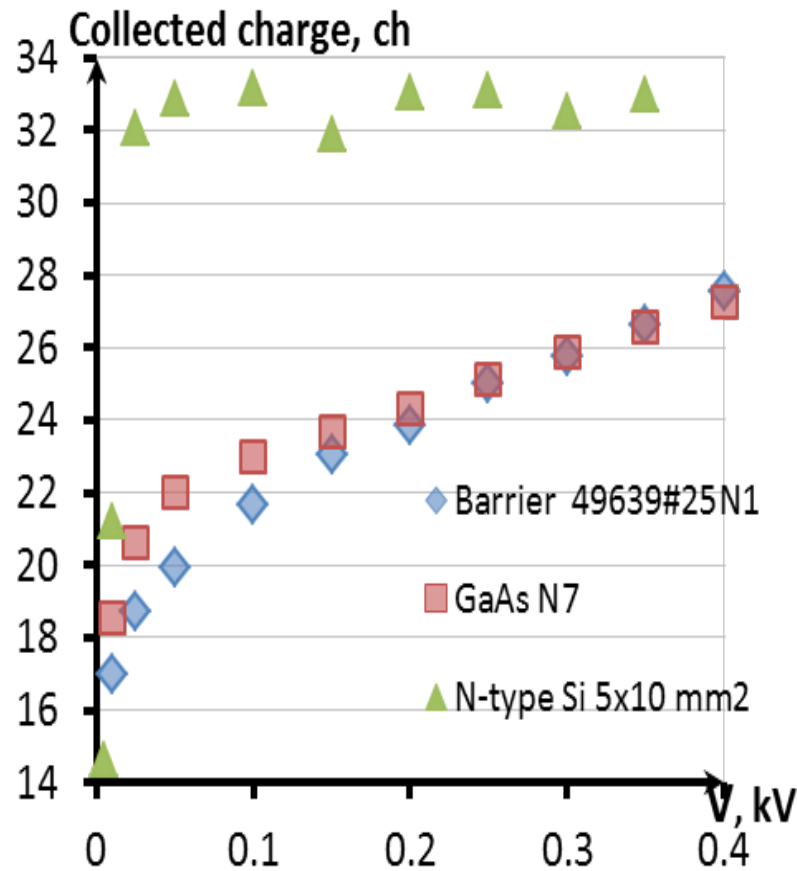
Resistive GaAs:Cr

Sr90_MIP_ch4_9639_25N1-100V_0.7Gss_599ns_20160905_PED+Sig1_0ch



pπvn junction structure GaAs:Cr

CCE measurement



Linac-200 at JINR

Part of refurbished 800 MeV linac MEA from NIKHEF



- 22 MeV electrons
- Current in bunch $15 \mu\text{A}$
- Bunch width $2 \mu\text{s}$
- Bunch frequency 10-250 Hz
- Focal spot $\sim 1 \text{ mm}$, can be defocused up to 20 mm
- Estimated dose rate for GaAs $\sim 600 \text{ kGy/hour}$

Summary and plans

- GaAs:Cr detectors based on $\pi\nu$ junction structures demonstrated an excellent radiation hardness during the LHC R&D in Protvino. Lack of interest in the next decades due to the lower efficiency to X-rays in comparison with resistive GaAs:Cr
- Radiation hardness tests of GaAs:Cr detectors based on $\pi\nu$ junction are planned at JINR during October, 1-10 this year
- If the results are encouraging, maybe we need to make a full-scale pad plane for the future FCAL beam tests?